



SPN166T06

N-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPN166T06 is the N-Channel logic enhancement mode power field effect transistor which is produced using super high cell density DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suitable for synchronous rectifier application, Motor control power management and other Power Tool circuits. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed.

APPLICATIONS

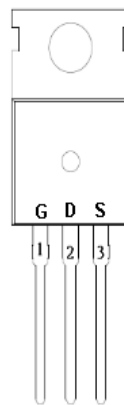
- DC/DC Converter
- Load Switch
- SMPS Secondary Side Synchronous Rectifier
- Motor Control
- Power Tool

FEATURES

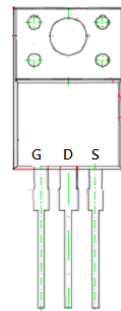
- ◆ 60V/166A, $R_{DS(ON)}=3.0m\Omega@V_{GS}=10V$
 $R_{DS(ON)}=4.5m\Omega@V_{GS}=4.5V$
- ◆ Super high density cell design for extremely low $R_{DS(ON)}$
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ TO-220-3L/TO-220F-3L/PPAK5x6-8L package design

PIN CONFIGURATION

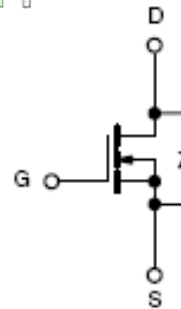
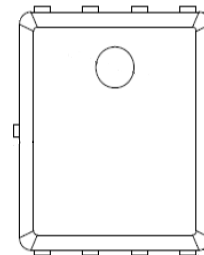
TO-220



TO-220F



PPAK 5x6



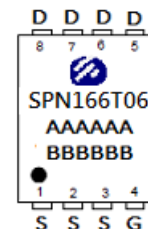
PART MARKING



A : Lot Code
B : Date Code



A: Lot Code
B: Date Code
(YYMMDD)



A : Lot Code
B : Date Code
(YY / MM / DD)



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PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	D	Drain
3	S	Source

PPAK5x6 PIN DESCRIPTION

Pin	Symbol	Description
1	S	Source
2	S	Source
3	S	Source
4	G	Gate
5	D	Drain
6	D	Drain
7	D	Drain
8	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN166T06T220TGB	TO-220-3L	SPN166T06
SPN166T06T220FTGB	TO-220F-3L	SPN166T06
SPN166T06DN8RGB	PPAK5x6-8L	SPN166T06

- ※ SPN166T06T220TGB : Tube ; Pb – Free ; Halogen – Free
- ※ SPN166T06T220FTGB : Tube ; Pb – Free ; Halogen – Free
- ※ SPN166T06DN8RGB : Tape&Reel ; Pb – Free ; Halogen - Free



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ABSOLUTE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit	
Drain-Source Voltage	V _{DSS}	60	V	
Gate –Source Voltage	V _{GSS}	±20	V	
Continuous Drain Current (Silicon Limited)(TO-220/TO-220F)	I _D	Tc=25°C	166	A
		Tc=70°C	118	
Continuous Drain Current (Silicon Limited)(PPAK5x6)	I _D	Tc=25°C	161	A
		Tc=70°C	102	
Pulsed Drain Current	I _{DM}	400	A	
Power Dissipation @ Tc=25°C	P _D	TO-220	104	W
Power Dissipation @ Tc=25°C		TO-220F	93	
Power Dissipation @ Tc=25°C		PPAK5x6	83	
Avalanche Energy with Single Pulse (Tc=25°C , L=0.1mH.)	EAS	73	mJ	
Operating Junction Temperature	T _J	-55/150	°C	
Storage Temperature Range	T _{STG}	-55/150	°C	
Thermal Resistance-Junction to Case (TO-220/TO-220F)	R _{θJC}	1.2	°C/W	
Thermal Resistance-Junction to Case (PPAK5x6)	R _{θJC}	1.5	°C/W	

Note :

The maximum current rating is package limited at 78A for TO-220F-3L

The maximum current rating is package limited at 80A for PPAK5x6-8L



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ELECTRICAL CHARACTERISTICS

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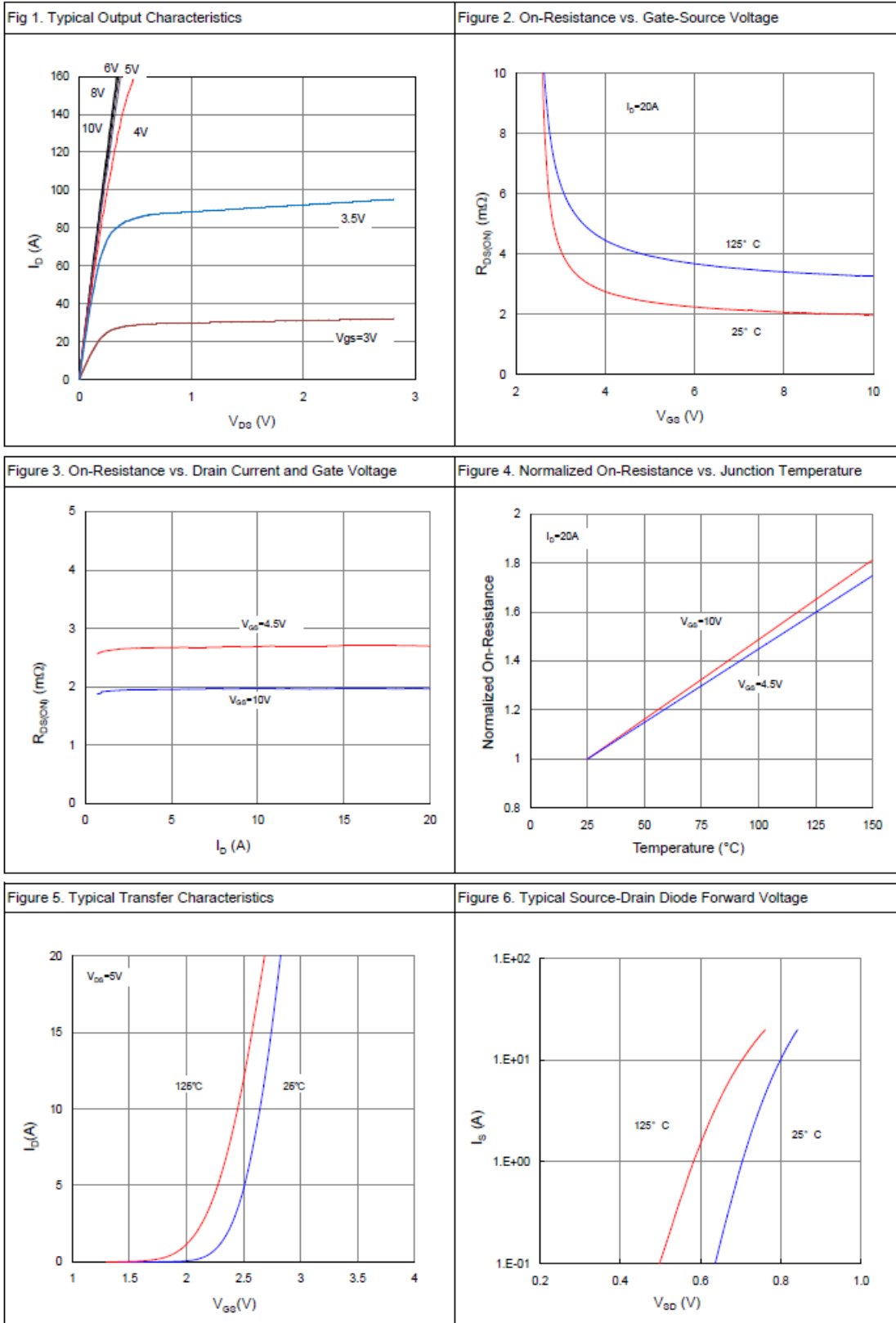
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	60			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.0	1.6	2.4	
Gate Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=48V, V_{GS}=0V$ $T_J=25^\circ C$			1	uA
		$V_{DS}=48V, V_{GS}=0V$ $T_J=100^\circ C$			100	
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=20A$		2.5	3.0	mΩ
		$V_{GS}=4.5V, I_D=20A$		3.5	4.5	
Forward Transconductance	g_{fs}	$V_{DS}=5V, I_D=20A$		80		S
Diode Forward Voltage	V_{SD}	$I_S=20A, V_{GS}=0V$		0.9	1.2	V
Gate Resistance	R_G	$V_{GS}=0V, V_{DS}$ open, $f=1MHz$		1.6		Ω
Dynamic						
Total Gate Charge (10V)	Q_g	$V_{DS}=30V, V_{GS}=10V$ $I_D=20A$		64		nC
Total Gate Charge (4.5V)	Q_g			31		
Gate-Source Charge	Q_{gs}			18		
Gate-Drain Charge	Q_{gd}			12		
Input Capacitance	C_{iss}	$V_{DS}=30V, V_{GS}=0V$ $f=1MHz$		4424		pF
Output Capacitance	C_{oss}			1670		
Reverse Transfer Capacitance	C_{rss}			73		
Turn-On Time	$t_{d(on)}$	$V_{DD}=30V, I_D=20A$ $V_{GEN}=10V, R_G=10\Omega$		14		nS
	t_r			11		
Turn-Off Time	$t_{d(off)}$			58		
	t_f			17		



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TYPICAL CHARACTERISTICS





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TYPICAL CHARACTERISTICS

Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

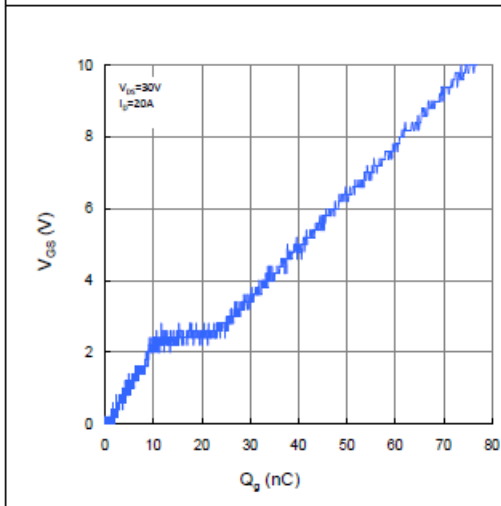


Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

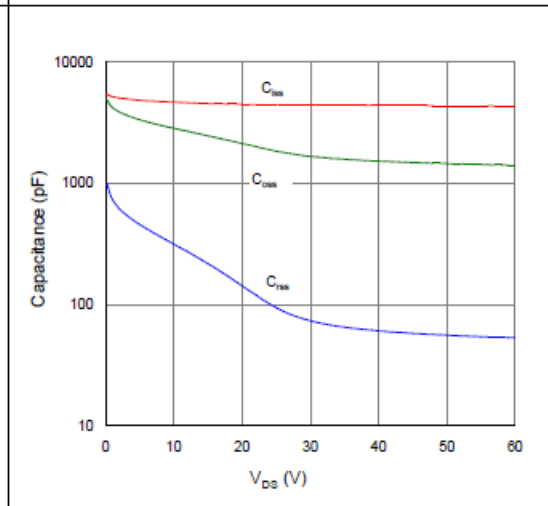


Figure 9. Maximum Safe Operating Area

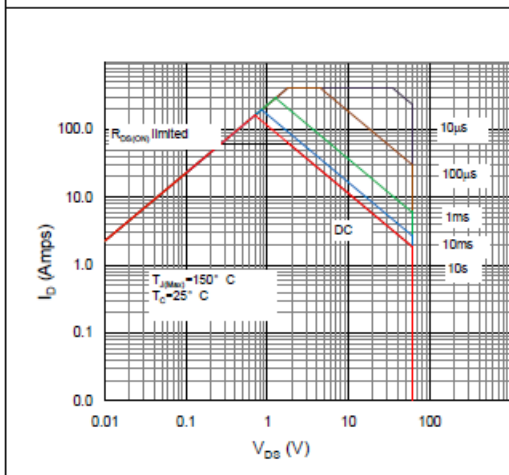


Figure 10. Maximum Drain Current vs. Case Temperature

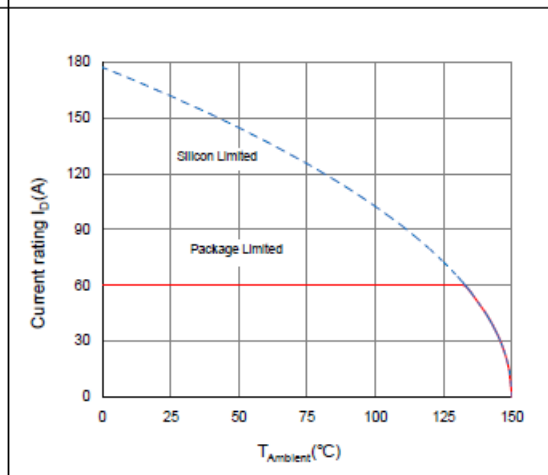
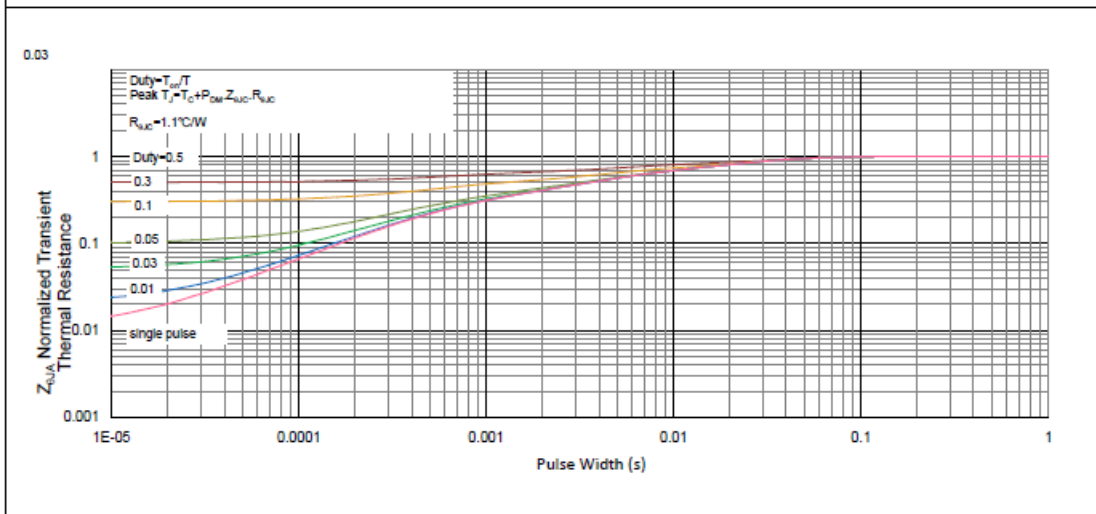


Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Ambient





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